EXAMINED BY : *Vincent Uh*	EMERGING DISPLAY	FILE NO . CAS-0006810
		ISSUE : AUG.21, 2009
APPROVED BY: *David Chang*	TECHNOLOGIES CORPORATION	TOTAL PAGE : 22
		VERSION : 4

CUSTOMER   ACCEPTANCE   SPECIFICATIONS

MODEL   NO. :

E T Q 5 7 0 G 2 D M 6
(RoHS)

FOR   MESSRS :

_____

CUSTOMER'S APPROVAL

DATE :

_____

BY :

_____

02101300-01-02

RECORDS OF REVISION	DOC . FIRST ISSUE JAN.23, 2009

DATE	REVISED PAGE NO.	SUMMARY
MAR.04, 2009	1	2. MECHANICAL SPECIFICATIONS (9) COLOR ------ 16.7M → 262K
	3	4. ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY CURRENT FOR VCOM DRIVER	ICC	VCC–VSS = 3.3V LED B/L=ON	—	630	720	mA	

↓

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY CURRENT FOR VCOM DRIVER	ICC	VCC–VSS = 3.3V LED B/L=ON	—	(630)	(720)	mA	

DATE	REVISED PAGE NO.	SUMMARY
	7	7. OUTLINE DIMENSIONS MARK △ : ADDING PULL TAPE
	8	8. BLOCK DIAGRAM ADD FRAME GROUND
	12	11.1 POWER SUPPLY FOR LCM

11.2 THE BRIGHTNESS CONTROLLED BY BACKLIGHT CURRENT OF LEDCTRL

DATE	REVISED PAGE NO.	SUMMARY
APR.15, 2009	7	7. OUTLINE DIMENSIONS MARK △2 : MODIFY CN1 TYPE
AUG.21, 2009	3	4. ELECTRICAL CHARACTERISTICS POWER SUPPLY CURRENT FOR VCOM DRIVER： TYP.=(630) → 450, MAX.=(720) → 580

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| EMERGING   DISPLAY | MODEL NO. | VERSION | PAGE |
| TECHNOLOGIES CORPORATION | ETQ570G2DM6 | 4 | 0-2 |

T A B L E   O F   C O N T E N T S

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1.   GENERAL SPECIFICATIONS

  1 . 1   APPLICATION NOTES FOR CONTROLLER/DRIVER
       PLEASE REFER TO :

              H I M A X   H X 8 2 1 8
              H I M A X   H X 8 6 1 5

  1 . 2   MATERIAL SAFETY DESCRIPTION
       ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
       INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
       MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
       BIPHENYLS (PBB) AND POLYBROMINATED
       DIPHENYL ETHERS (PBDE)

2.   MECHANICAL SPECIFICATIONS
       (1) DIAGONALS   --------------------------------- 5.7 inch
       (2) NUMBER OF DOTS   ------------------------- 320W * (RGB) * 240H DOTS
       (3) MODULE SIZE --------------------------------- 142.1W * 100.4H * 11D (MAX.) mm
                                                              (WITHOUT FPC)
       (4) EFFECTIVE AREA   ----------------------------- 117.2W * 88.4H mm
       (5) ACTIVE AREA   --------------------------------- 115.2W * 86.4H mm
       (6) DOT SIZE   -------------------------------------- 0.12W * 0.36H mm
       (7) PIXEL SIZE   ------------------------------------- 0.36W * 0.36H mm
       (8) LCD TYPE   ---------------------------------- TFT , TRANSMISSIVE
       (9) COLOR   ----------------------------------- 262K
       (10) VIEWING DIRECTION   ---------------------- 6 O'CLOCK
       (11) BACK LIGHT   ------------------------------------ LED , COLOR : WHITE
       (12) INTERFACE MODE --------------------------------- RGB 18 BIT PARALLEL

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3 . ABSOLUTE MAXIMUM RATINGS

3 . 1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD–VSS	-0.3	7.0	V	
	VCC–VSS	-0.3	7.0	V	
INPUT SIGNAL VOLTAGE	VL–VSS	-0.3	VCC+0.3	V	
STATIC ELECTRICITY	—	—	—	V	NOTE (1)
LED BACKLIGHT POWER DISSIPATION	PD	—	1.28	W	
LED BACKLIGHT FORWARD CURRENT	IF	—	0.06	A	
LED BACKLIGHT REVERSE VOLTAGE	VR	—	45	V	

NOTE（1）: LCM SHOULD BE GROUNDED DURING HANDING LCM.

3 . 2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS .

I T E M	OPERATING		STORAGE		REMARK
	MIN.	MAX.	MIN.	MAX.	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1) , (2)
HUMIDITY	NOTE (3)		NOTE (3)		WITHOUT CONDENSATION
VIBRATION	—	2.45 m/s^2 (0.25 G)	—	11.76 m/s^2 (1.2 G)	5~20Hz, 1HR 20~500Hz(20Hz), 1HR 20~500Hz(500Hz), 1HR X, Y, Z, TOTAL 3HRS
SHOCK	—	29.4 m/s^2 (3 G)	—	490 m/s^2 (5 0 G)	10 m SECONDS XYZ DIRECTIONS 1 TIME EACH
CORROSIVE GAS	NOT ACCEPTABLE		NOT ACCEPTABLE		

NOTE（1）: Ta AT -30°C : 48HRS MAX .
             80°C : 168HRS MAX .
NOTE（2）: BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT
             TEMPERATURE THIS PHENOMENON IS REVERSIBLE .
NOTE（3）: Ta ≤ 60°C : 90%RH MAX (96HRS MAX).
             Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY
                 OF 90%RH AT 60°C(96HRS MAX).

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4. ELECTRICAL CHARACTERISTICS

Ta = 25 °C

| PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE FOR DIGITAL	VDD–VSS	—	3	3.3	3.6	V	
POWER SUPPLY VOLTAGE FOR VCOM DRIVER	VCC–VSS	—	3	3.3	3.6	V	
POWER SUPPLY CURRENT FOR DIGITAL	IDD	VDD–VSS =3.3V	—	8	11	mA	NOTE (1)
POWER SUPPLY CURRENT FOR VCOM DRIVER	ICC	VCC–VSS = 3.3V LED B/L=ON	—	450	580	mA	
LOW LEVEL INPUT VOLTAGE	VIL	—	0	—	0.3*VDD	V	NOTE (2)
HIGH LEVEL INPUT VOLTAGE	VIH	—	0.7*VDD	—	VDD	V	
LOW LEVEL OUTPUT VOLTAGE	VOL	IOL = 400μA	0	—	0.2*VDD	V	NOTE (3)
HIGH LEVEL OUTPUT VOLTAGE	VOH	IOH = -400μA	0.8*VDD	—	VDD	V	
FRAME FREQUENCY	fFRAME	—	—	83	92	Hz	
DOT DATA CLOCK	DCLK	—	—	6.4	7.1	MHz	
POWER SUPPLY FOR LED BACKLIGHT	V_F	I_F=40mA	28	30	32	V	NOTE (4)
LED LIFE TIME	—	—	30000	40000	—	HRS	

NOTE (1) : THE DISPLAY PATTERN IS ALL "WHITE".
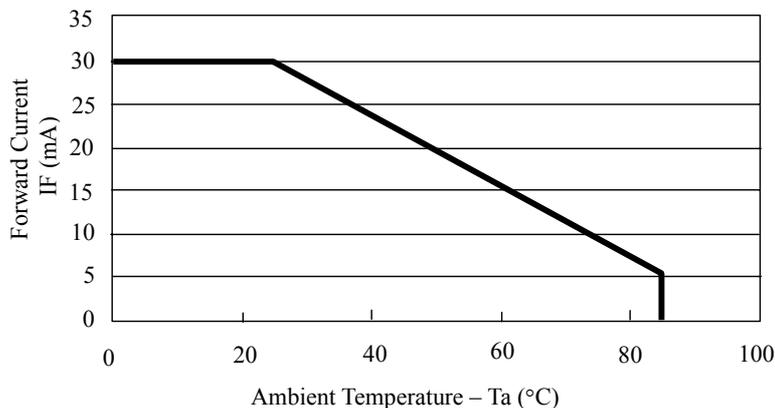NOTE (2) : APPLIED TO TERMINALS /RESET, HSYNC, VSYNC, ENB, DCLK, B5~B0, G5~G0, R5~R0.
NOTE (3) : APPLIED TO TERMINALS B5~B0, G5~G0, R5~R0.
NOTE (4) : INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT
(VF=VBL+(A)—VBL1–(K1)=VBL+(A) —VBL2–(K2))
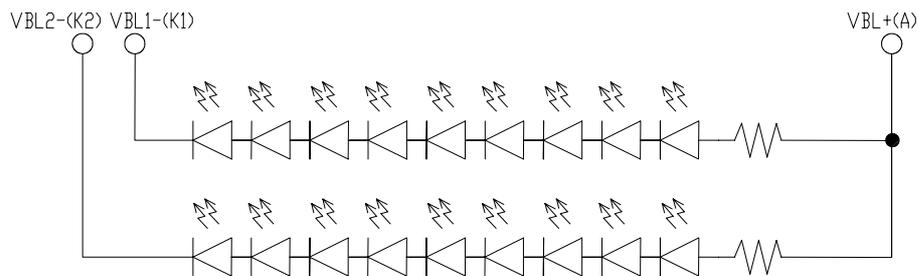
NOTE (5) : AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER LED)

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5. TIMING CHARACTERISTICS

5.1 DIGITAL PARALLEL RGB INTERFACE

SIGNAL	ITEM		SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK	FREQUENCY		TCLK	—	6.4	7.1	MHz
	HIGH TIME		TCH	—	78	—	ns
	LOW TIME		TCL	—	78	—	ns
DATA	SETUP TIME		TDS	12	—	—	ns
	HOLD TIME		TDH	12	—	—	ns
HSYNC	PERIOD		TH	—	408	—	DCLK
	PULSE WIDTH		THP	—	30	—	DCLK
	BACK-PORCH		THB	—	38	—	DCLK
	DISPLAY PERIOD		THD	—	320	—	DCLK
	FRONT-PORCH		THF	—	20	—	DCLK
VSYNC	PERIOD	NTSC	TV	—	262.5	—	TH
		PAL			312.5		
	PULSE WIDTH		TVP	1	3	5	TH
	BACK-PORCH	NTSC	TVB	—	15	—	TH
	BACK-PORCH	PAL			23		
	DISPLAY PERIOD		TVD	—	240	—	TH
	FRONT-PORCH	NTSC	TVF	—	4.5	—	TH
		PAL			46.5		

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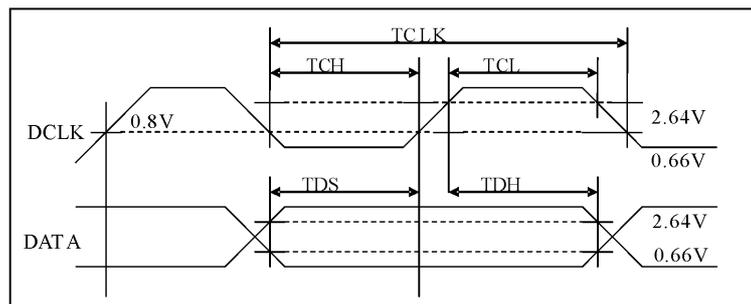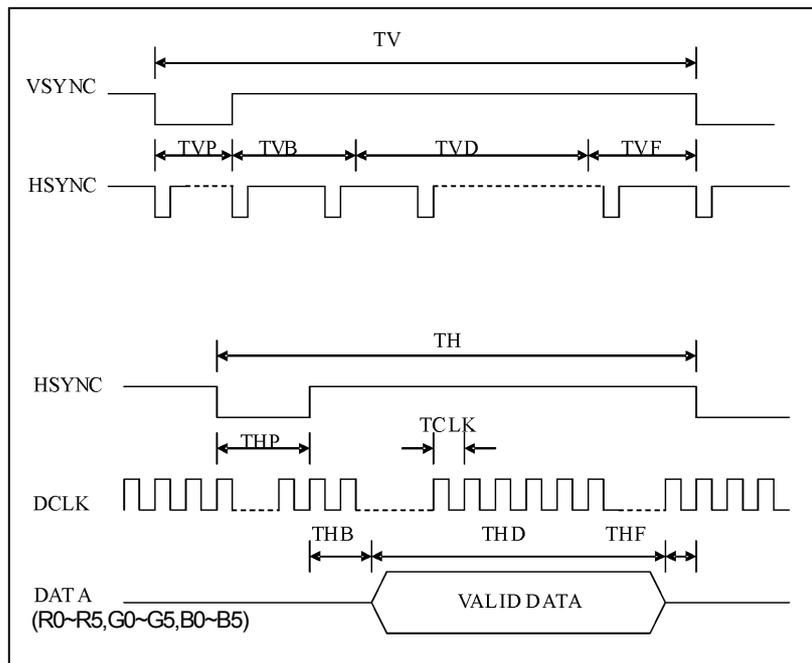
6. OPTICAL CHARACTERISTICS (NOTE 1)
6.1 OPTICAL CHARACTERISTICS

Ta = 25 ± 2 °C

ITEM		SYMBOL	CONDITION		MIN.	TYP.	MAX.	UNIT	REMARK
VIEWING ANGLE		θ_{y+}	CR ≥ 10	$\theta_x=0°$	55	60	—	deg.	NOTE (2) NOTE (3)
		θ_{y-}			70	75	—		
		θ_{x+}		$\theta_y=0°$	70	75	—		
		θ_{x-}			70	75	—		
CONTRAST RATIO		CR	$\theta x=0°$, $\theta y=0°$		300	400	—	—	NOTE (3)
RESPONSE TIME		T_R (rise)	$\theta x=0°$, $\theta y=0°$		—	15	30	msec	NOTE (4)
		T_F (fall)			—	35	50		
COLOR OF CIE COORDINATE	WHITE	Wx	$\theta x=0°$, $\theta y=0°$ I_F =40mA NTSC:60%		0.27	0.32	0.37	—	NOTE (5)
		Wy			0.30	0.35	0.40		
	RED	Rx			0.58	0.63	0.68	—	
		Ry			0.31	0.36	0.41		
	GREEN	Gx			0.28	0.33	0.38	—	
		Gy			0.55	0.60	0.65		
	BLUE	Bx			0.09	0.14	0.19	—	
		By			0.06	0.11	0.16		
THE BRIGHTNESS OF MODULE		B	$\theta x=0°$, $\theta y=0°$ I_F=40mA		450	500	—	cd/m^2	NOTE (6)
THE UNIFORMITY OF MODULE		—			75	80	—	%	

NOTE (1) : TEST EQUIPMENT SETUP :
   AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.
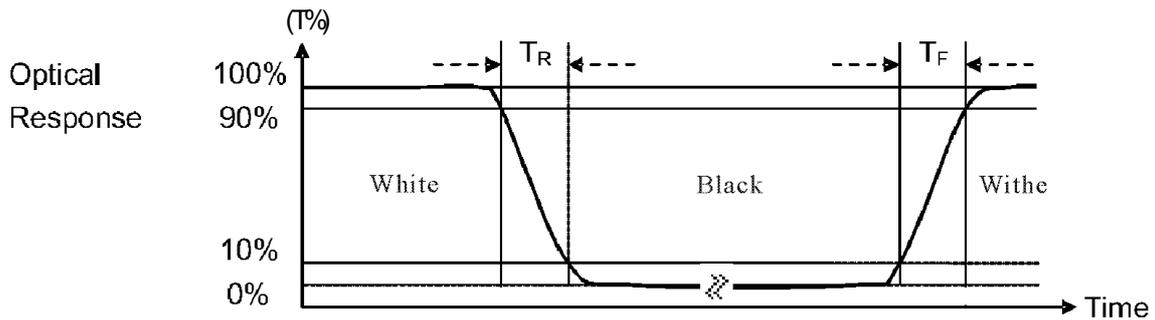

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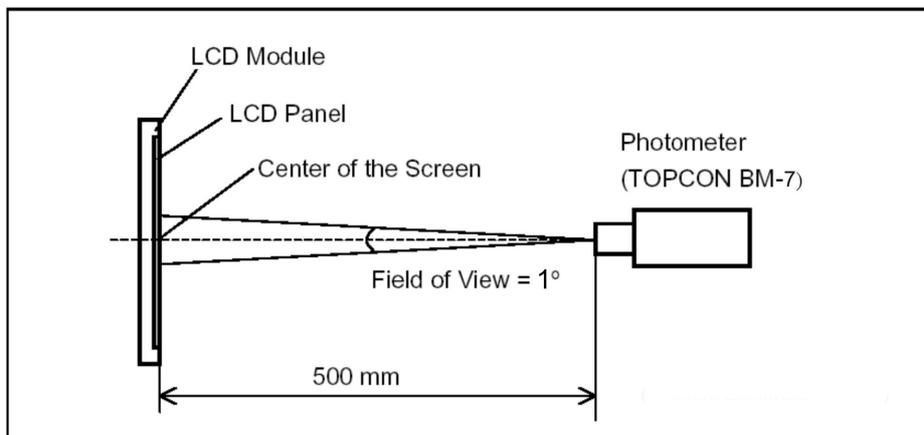
NOTE (2) : DEFINITION OF VIEWING ANGLE :
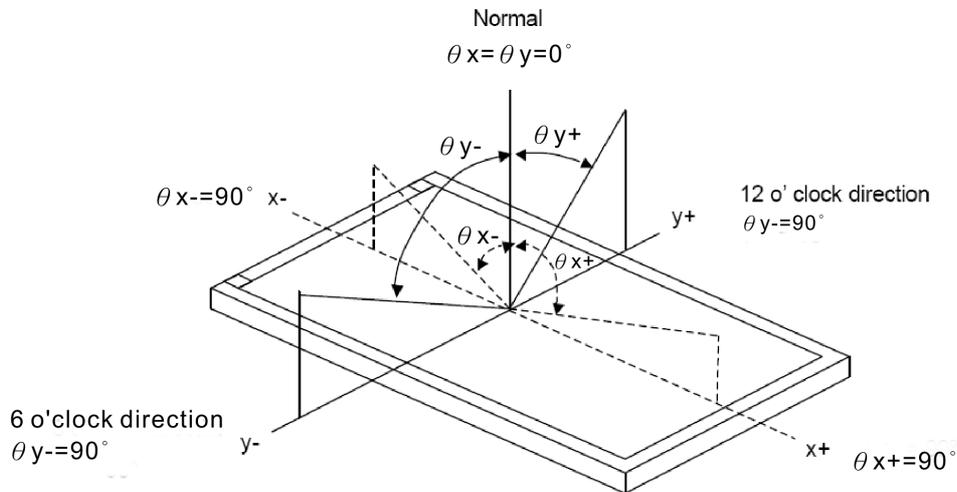
NOTE (3) : DEFINITION OF CONTRAST RATIO :

$$CONTRAST\ RATIO(CR) = \frac{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "WHITE\ STATE"}{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "BLACK\ STATE"}$$

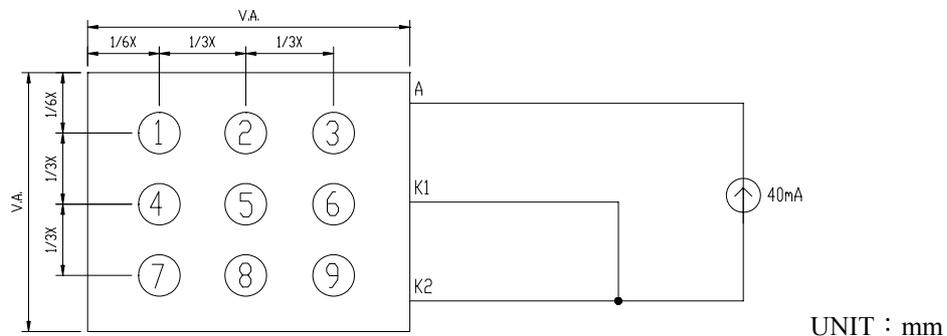NOTE (4) : DEFINITION OF RESPONSE TIME : TR AND TF
THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.

NOTE (5) : THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL
THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.
NOTE (6) : BRIGHTNESS MEASURED WHEN LCD IS AT " WHITE STATE "

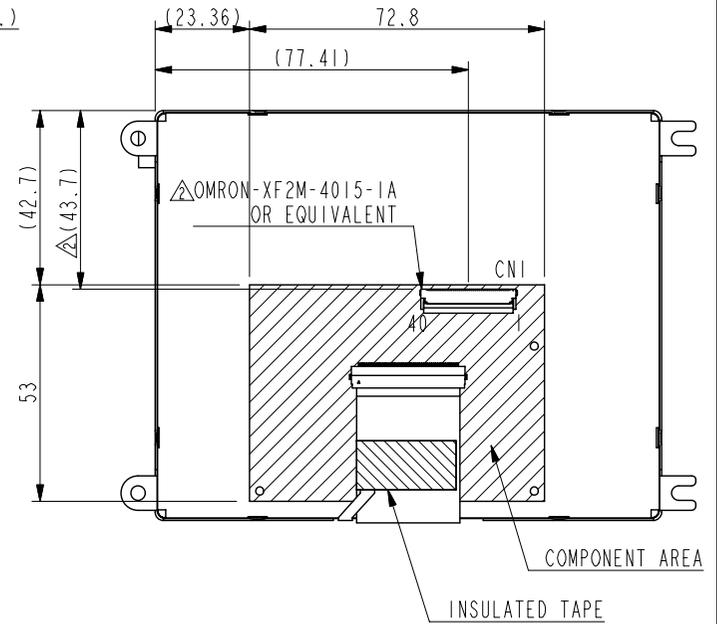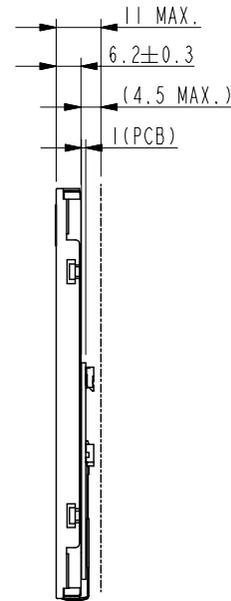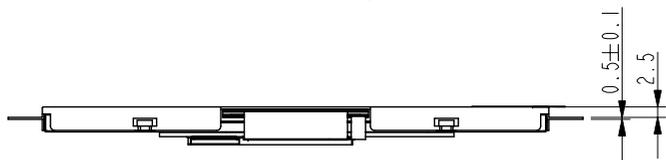## 6.2   THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY

UNIT：mm

6.3   THE CALCULATING METHOD OF UNIFORMITY

$$UNIFORMITY: \left[1 - \frac{MAXIMUM\ BRIGHTNESS - MINIMUM\ BRIGHTNESS}{AVERAGE\ BRIGHTNESS} \right] \times 100\%$$

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7. OUTLINE DIMENSIONS

142.1
133.6±0.2
125.1
118.2 (FRAME OPENING)
V.A. 117.2 (POLARIZER)
A.A. 115.2±0.1

4.25
4.25
(3.45)
(3.95)
(4.95)

6.75
86.9±0.2
8.5(*4)
3.5(*2)

320(RGB)*240 DOTS

⚠PULL TAPE

(4.95)
(3.95)
(3.45)

A.A. 86.4±0.1
V.A. 88.4 (POLARIZER)
89.4 (FRAME OPENING)
100.4

Ø3.5±0.2(*2)
(1)
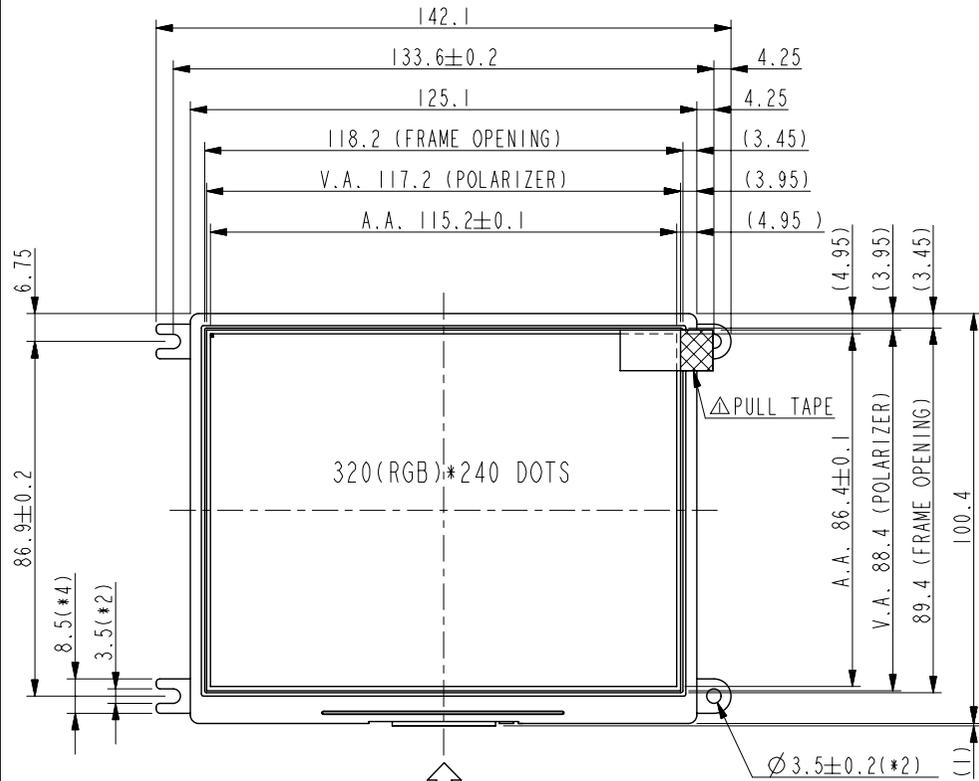
VIEWING DIRECTION
Best Contrast but with Gray Level Inversion

11 MAX.
6.2±0.3
(4.5 MAX.)
1(PCB)

0.5±0.1
2.5

(23.36)
72.8
(77.41)
(42.7)
⚠(43.7)
53

⚠OMRON-XF2M-4015-1A
OR EQUIVALENT

CN1
40

COMPONENT AREA
INSULATED TAPE

UNIT : mm
SCALE : NTS
NOT SPECIFIED TOLERANCE IS ± 0.5
NOTE:MARK ⚠ MODIFY (NUMBER NOTE MODIFY VERSION)

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8. BLOCK DIAGRAM

TFT LCD PANEL

SOURCE DRIVER
T-CON

GATE
DRIVER

FRAME
GROUND

R
0Ω

PCB

VGL,VGH,AVDD

VCOM,POL,VDD,VCC

LED
BACKLIGHT

1./RESET
2.VSS
3.B5
4.B4
5.B3
6.B2
7.B1
8.B0
9.VSS
10.G5
11.G4
12.G3
13.G2
14.G1
15.G0
16.VSS
17.R5
18.R4
19.R3
20.R2
21.R1
22.R0
23.VSS
24.DCLK
25.VSS
26.HSYNC
27.VSYNC
28.ENB
29.PWCTRL
30.VDD
31.VSS
32.VSS
33.VCC
34.VCC
35.NC
36.LEDCTRL
37.NC
38.NC
39.NC
40.NC

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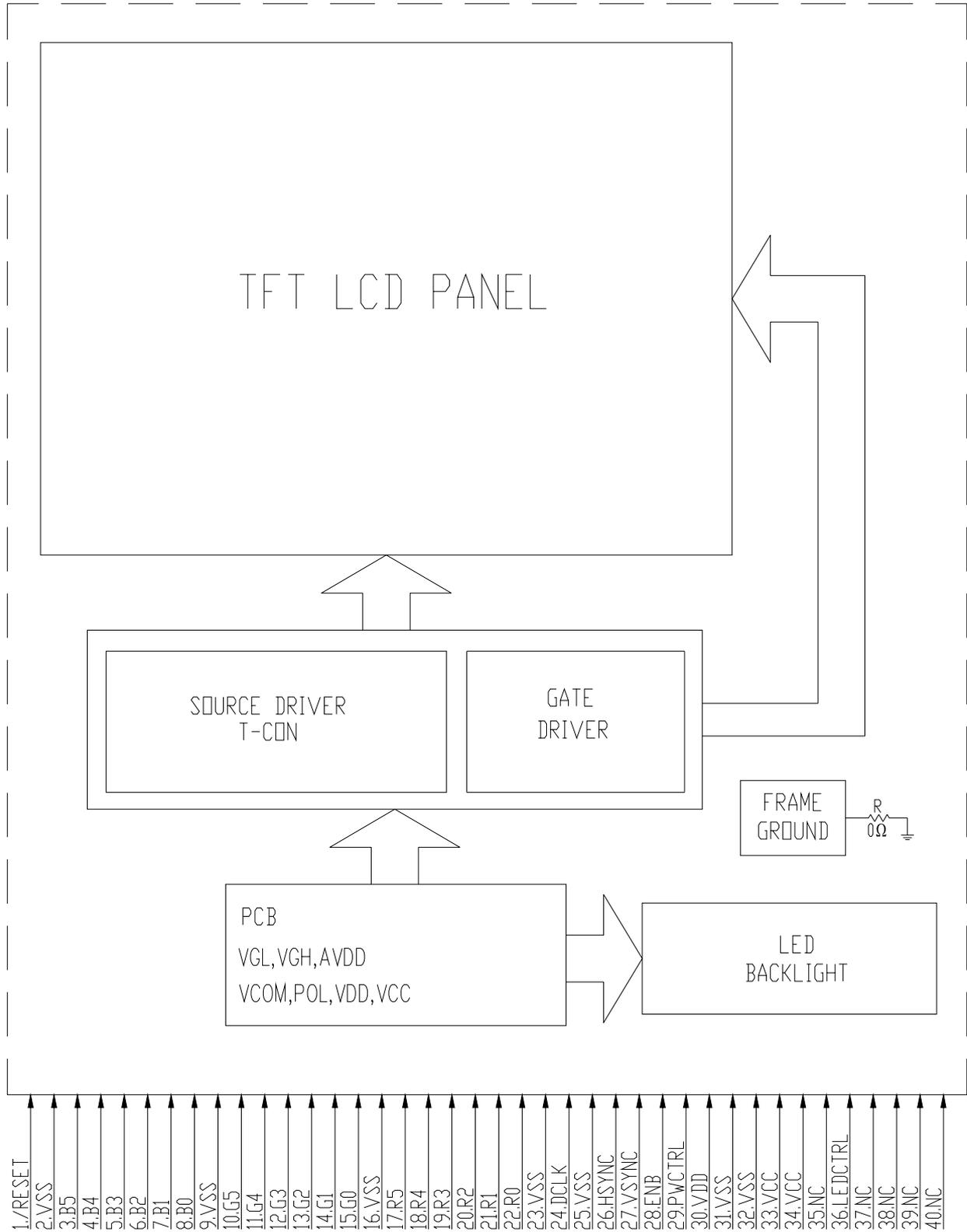
9. DETAIL DRAWING OF DOT MATRIX

115.2

0.36

0.12

0.36

| R | G | B |
| R | G | B |

86.4

320(RGB)*240 DOTS

| R | G | B |
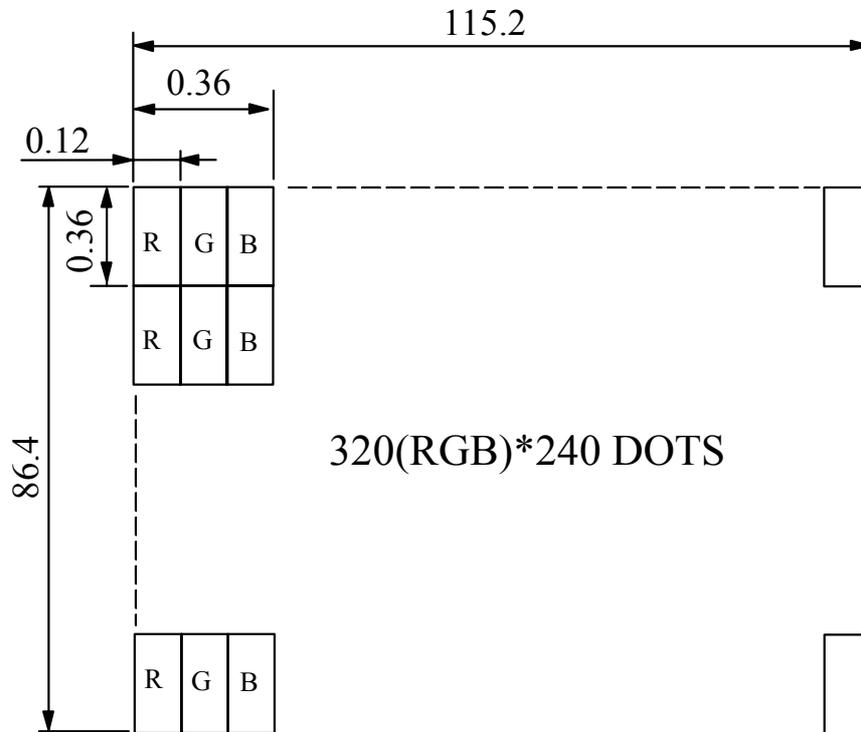
UNIT : mm
SCALE : NTS
NOT SPECIFIED TOLERANCE IS ± 0.1
DOTS MATRIX TOLERANCE IS ± 0.01

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10. INTERFACE SIGNALS

PIN NO	SYMBOL	I/O	FUNCTION
1	/RESET	I	HARDWARE RESET
2	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
3	B5	I	BLUE DATA BIT 5
4	B4	I	BLUE DATA BIT 4
5	B3	I	BLUE DATA BIT 3
6	B2	I	BLUE DATA BIT 2
7	B1	I	BLUE DATA BIT 1
8	B0	I	BLUE DATA BIT 0
9	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
10	G5	I	GREEN DATA BIT 5
11	G4	I	GREEN DATA BIT 4
12	G3	I	GREEN DATA BIT 3
13	G2	I	GREEN DATA BIT 2
14	G1	I	GREEN DATA BIT 1
15	G0	I	GREEN DATA BIT 0
16	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
17	R5	I	RED DATA BIT 5
18	R4	I	RED DATA BIT 4
19	R3	I	RED DATA BIT 3
20	R2	I	RED DATA BIT 2
21	R1	I	RED DATA BIT 1
22	R0	I	RED DATA BIT 0
23	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
24	DCLK	I	DOT DATA CLOCK
25	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
26	HSYNC	I	HORIZONTAL SYNC INPUT
27	VSYNC	I	VERTICAL SYNC INPUT
28	ENB	I	DATA ENABLE INPUT
29	PWCTRL	I	(see table below)

For PIN 29 (PWCTRL):

LOGIC LEVEL H=3.3V L=0V	PWCTRL	REMARK
	H	POWER ON
	L	SHUTDOWN

WHEN INTERNAL LED DRIVER : JP15 1-2(DEFAULT)
WHEN EXTERNAL LED DRIVER : JP15 2-3

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PIN NO	SYMBOL	I/O	FUNCTION
30	VDD	P	POWER SUPPLY FOR DIGITAL CIRCUIT
31	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
32	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)
33	VCC	P	POWER SUPPLY FOR VCOM DRIVER CIRCUIT
34	VCC	P	POWER SUPPLY FOR VCOM DRIVER CIRCUIT
35	NC	—	NON CONNECTION (USING INTERNAL LED DRIVER) OR ANODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER：JP5 1-2 (DEFAULT) WHEN EXTERNAL LED DRIVER：JP5 2-3
36	LEDCTRL	I	BRIGHTNESS CONTROL FOR LED BACKLIGHT； LEDCTRL (USING INTERNAL LED DRIVER) OR CATHODE (USING EXTERNAL LED DRIVER) WHEN INTERNAL LED DRIVER：JP6 1-2 (DEFAULT) JP14 1-2 (DEFAULT) WHEN EXTERNAL LED DRIVER：JP6 2-3 JP14 NON CONNECTION
37	NC	—	NON CONNECTION
38	NC	—	NON CONNECTION
39	NC	—	NON CONNECTION
40	NC	—	NON CONNECTION

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1 1 . POWER SUPPLY
1 1 .1 POWER SUPPLY FOR LCM

```
        ┌──────────────────┐  VDD ─────────────────┐
        │                  │                        │
        │                  │                       ─┴─  3.3V
        │   TFT   LCD       │                       ───
        │                  │                        │
        │                  │  VSS ─────────────────┘
        ├──────────────────┤  VCC ──────────────┐
        │                  │                     │
        │   VCOM           │  VSS ──────────┐   ─┴─  3.3V
        │                  │                ●   ───
        │   CIRCUIT        │  LEDCTRL ──────┘   ─┬─  0~2.5V
        │                  │                     ───
        │                  │  PWCTRL ◄────────  ‾‾ON│ OFF
        └──────────────────┘
```

1 1 .2 THE BRIGHTNESS CONTROLLED BY BACKLIGHT CURRENT OF LEDCTRL
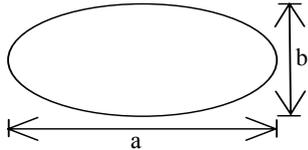
BACKLIGHT CURRENT V.S. LEDCTRL

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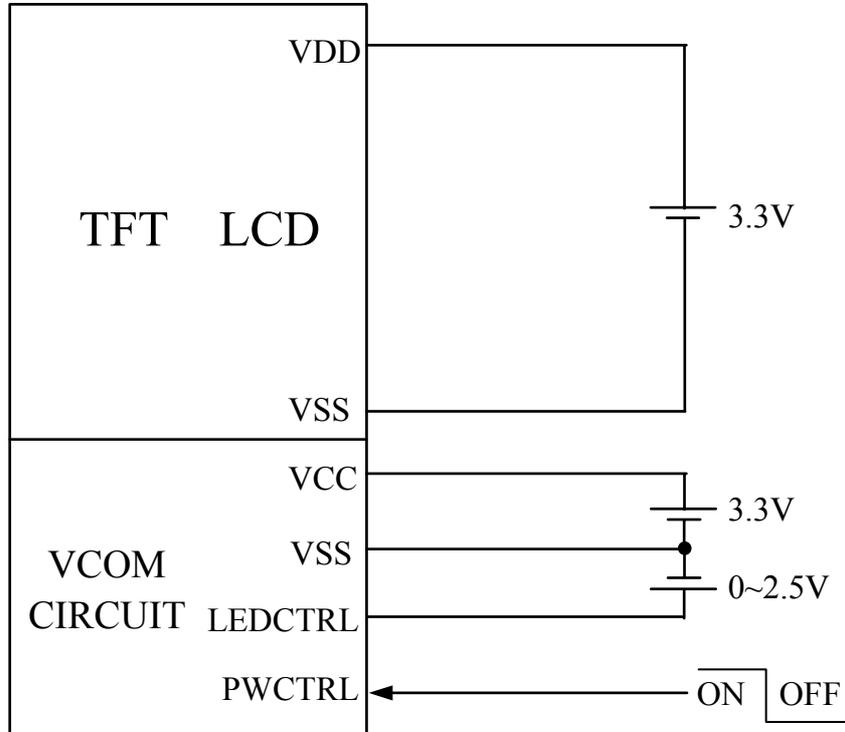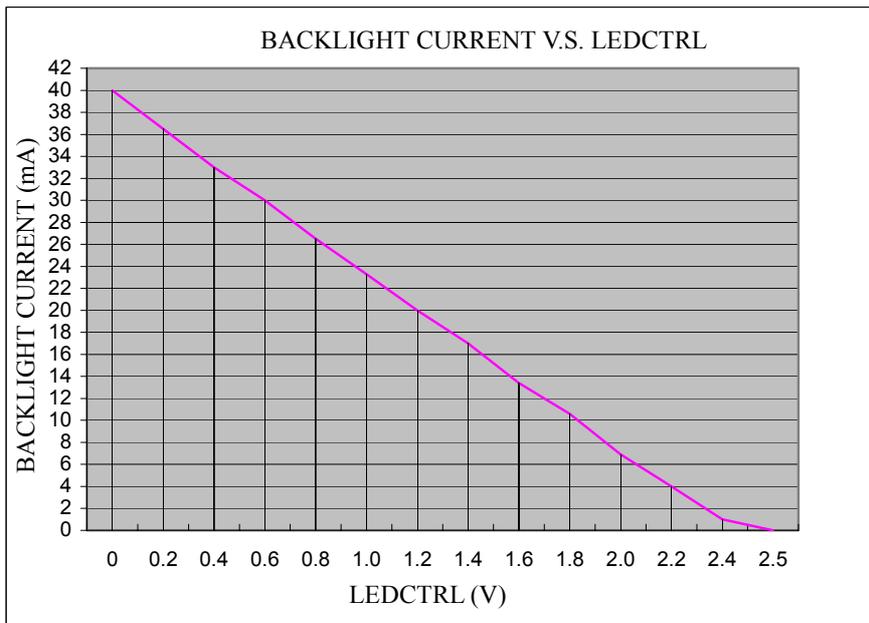
１２．INSPECTION CRITERION
　12.1　APPLICATION

　　THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE
　　DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO
　　CUSTOMERS

　12.2　INSPECTION CONDITIONS

　　　12.2.1　(1)OBSERVATION DISTANCE : 35cm±5cm
　　　　　　　(2)VIEW ANGLE :
　　　　　　　　NON-OPERATION CONDITION : ±5°
　　　　　　　　(PERPENDICULAR TO LCD PANEL SURFACE)
　　　　　　　　OPERATION CONDITION : ±45°
　　　　　　　　(PERPENDICULAR TO LCD PANEL SURFACE)
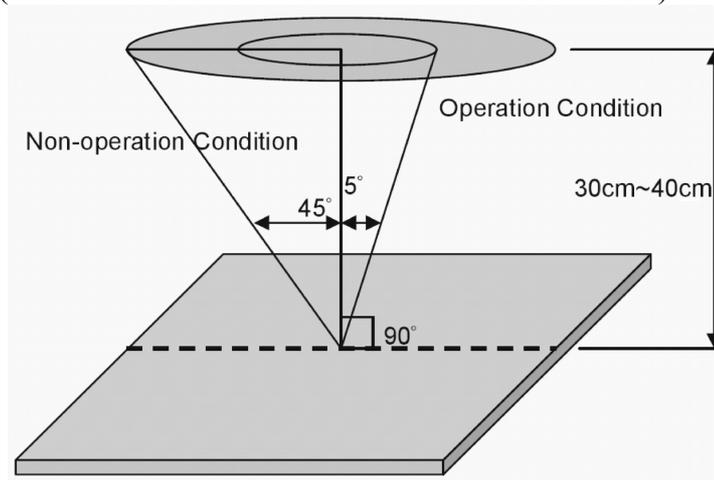
　　　12.2.2　ENVIRONMENT CONDITIONS :

AMBIENT TEMPERATURE		20°C~25°C
AMBIENT HUMIDITY		65±20%RH
AMBIENT ILLUMINATION	COSMETIC INSPECTION	MORE THAN 600Lux
	FUNCTIONAL INSPECTION	300~500 Lux

　　　12.2.3　INSPECTION LOT
　　　　　　　QUANTITY PER DELIVERY LOT FOR EACH MODEL

　　　12.2.4　INSPECTION METHOD
　　　　　　　A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE
　　　　　　　FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY
　　　　　　　(a)APPLICABLE STANDARD :
　　　　　　　　MIL-STD-105E
　　　　　　　　NORMAL INSPECTION, SINGLE SAMPLING
　　　　　　　　LEVEL Ⅱ
　　　　　　　(b)AQL : MAJOR DEFECT : AQL 0.65
　　　　　　　　　　　MINOR DEFECT : AQL 1.0

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12.3 INSPECTION STANDARDS

12.3.1 VISUAL DEFECTS CLASSIFICATION

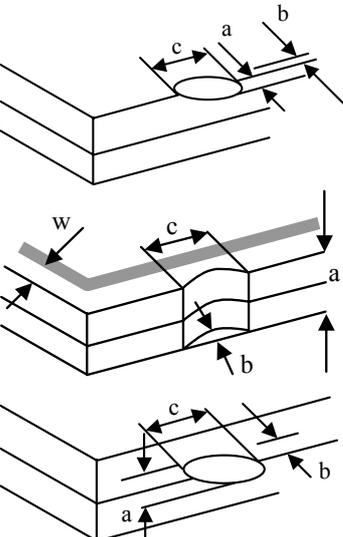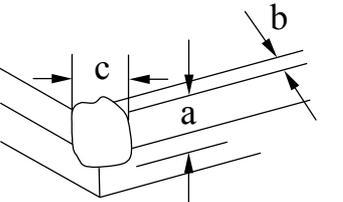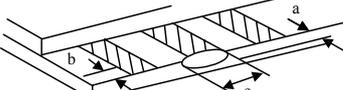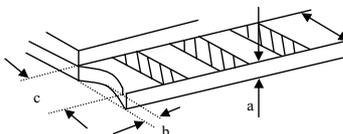| TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	• DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	0.65
	2.BACKLIGHT	• NO LIGHT • FLICKERING AND OTHER ABNORMAL ILLUMINATION	
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
MINOR DEFECT	1.DISPLAY ZONE	• BLACK/WHITE SPOT • BUBBLES ON POLARIZER • NEWTON RING • BLACK/WHITE LINE • SCRATCH • CONTAMINATION • LEVER COLOR SPREED	1.0
	2.BEZEL ZONE	• STAINS • SCRATCHES • FOREIGN MATTER	
	3.SOLDERING	• INSUFFICIENT SOLDER • SOLDERED IN INCORRECT POSITION • CONVEX SOLDERING SPOT • SOLDER BALLS • SOLDER SCRAPS	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

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12.3.2 MODULE DEFECTS CALSSIFICATION

NO.	ITEM	CRITERIA
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC
3.	DOT DEFECT	(1) INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS. (2) <table><tr><td>ITEMS</td><td>ACCEPTABLE COUNT</td></tr><tr><td>BRIGHT DOT</td><td>N ≤ 2</td></tr><tr><td>DARK DOT</td><td>N ≤ 3</td></tr><tr><td>TOAL BRIGHT AND DARK DOTS</td><td>N ≤ 4</td></tr></table> NOTE： 1. THE DEFINITION OF DOT： THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTIVE DOT. 2. BRIGHT DOT： DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN. 3. DARK DOT： DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	<table><tr><td>LENGTH：L</td><td>WIDTH：W</td><td>PERMISSIBLE NO.</td></tr><tr><td>L ≤ 0.3</td><td>W ≤ 0.05</td><td>IGNORE</td></tr><tr><td>0.3 < L ≤ 2.5</td><td>0.05 < W ≤ 0.1</td><td>4</td></tr><tr><td>2.5 < L</td><td>0.1 < W</td><td>NONE</td></tr></table> WIDTH：W mm, LENGH：L mm
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	<table><tr><td>AVERAGE DIAMETER (mm): D</td><td>NUMBER OF PIECES PERMITTED</td></tr><tr><td>D ≤ 0.15</td><td>IGNORE</td></tr><tr><td>0.15 < D ≤ 0.5</td><td>4</td></tr><tr><td>0.5 < D</td><td>NONE</td></tr></table> NOTE ：DIAMETER D=(a+b)/2

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NO.	ITEM	CRITERIA		

6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS		AVERAGE DIAMETER (mm) : D	NUMBER OF PIECES PERMITTED
		BUBBLE ON THE POLARIZER	D ≤ 0.25	IGNORE
			0.25 < D ≤ 0.5	N ≤ 5
			0.5 < D	NOTE
		SURFACE STATUS	D < 0.1 mm	IGNORE
			0.1 < D ≤ 0.3mm	N ≤ 3
		CF FAIL / SPOT	D < 0.1 mm	IGNORE
			0.1 < D ≤ 0.3mm	N ≤ 3

NOTE : (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA.
(2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON.
(3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING.
AVERAGE DIAMETER (D)=(a+b)/2

7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOW
8.	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUNG 6% ND FILTER
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.
11	PCB	(1)THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES. (2)NO OXIDATION OR CONTAMINATION PCB TERMINALS. (3)PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS. (4)THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART. (5)IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD, MAKE SURE IT IS SMOOTHED DOWN.

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NO.	ITEM	CRITERIA
12.	SOLDERING	(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT · SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 · SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER (3)PARTS ALIGMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE
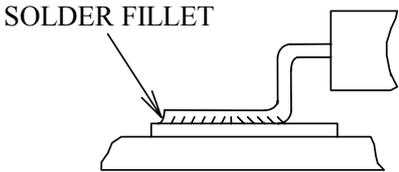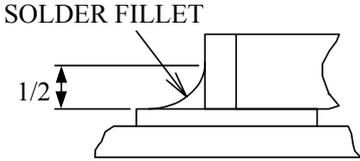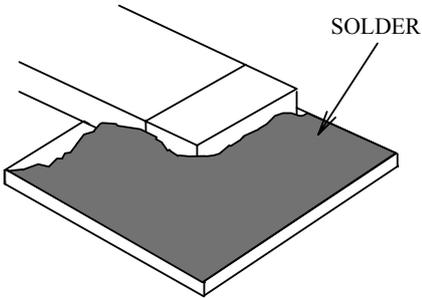
NO.	ITEM	CRITERIA

12.	SOLDERING	(b)CHIP COMPONENT
		   COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE
		   LEADS IS OFF THE PAD OUTLINE
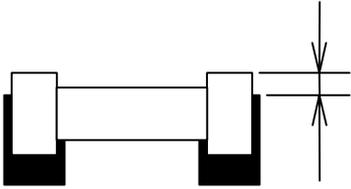		
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB.
		(5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS,
		   OXIDATION OR ICICLE.
		(6)NO RESIDUE OR SOLDER BALLS ON PCB.
		(7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.

13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.

14.	GENERAL APPEARANCE	(1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON
		   INTERFACE PIN (OLB) OF TCP.
		(2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP.
		(3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS
		   ON PRODUCT.
		(4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS.
		(5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE
		   INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE
		   INTERFACE PIN TO SEVER.
		(6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING
		   (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO
		   BROWN OR BLACK COLOR.
		(7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED.
		(8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET.
		(9)LCD PIN LOOSE OR MISSING PINS.
		(10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON
		   PACKAGING SPECIFICATION SHEET.
		(11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO
		   PRODUCT SPECIFICATION SHEET.
		(12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY
		   DIRT AND BREAK.

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NO.	ITEM	CRITERIA
15.	CRACKED GLASS	(see below)

THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE

GENERAL GLASS CHIP：

a	b	c
≤ t/2	< VIEWING AREA	≤ 1/8X
t/2 > , ≤ 2t	≤ W/2	≤ 1/8X

*W=DISTANCE BETWEEN
 SEALANT AREA AND LCD
 PANEL EDGE
 X = LCD SIDE LENGTH
 t = GLASS THICKNESS

CORNER PART：

a	b	c
≤ t/2	< VIEWING AREA	≤ 1/8X
> t/2 , ≤ 2t	≤ W/2	≤ 1/8X

*W=DISTANCE BETWEEN
 SEALANT AREA AND LCD
 PANEL EDGE
 X = LCD SIDE LENGTH
 t = GLASS THICKNESS

CHIP ON ELECTRODE PAD

a	b	c
≤ t	≤ 0.5mm	≤ 1/8X

* X=LCD SIDE WIDTH
 t =GLASS THICKNESS

a	b	c
≤ t	≤ 1/8X	≤ L

*X=LCD SIDE WIDTH
 t = GLASS THICKNESS
 L=ELECTRODE PAD LENGTH
①IF GLASS CHIPPING THE ITO
 TERMINAL, OVER 2/3 OF THE ITO MUST
 REMAIN AND BE, INSPECTED
 ACCORDING TO ELECTRODE
 TERMINAL SPECIFICATIONS
②IF THE PRODUCT WILL BE HEAT
 SEALED BY THE CUSTOMER,
 THE ALIGNMENT MARK MUST NOT
 BE DEMAGED

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12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMP / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C , 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -40°C FOR 30 MINUTES ~ +85°C FOR 30 MINUTES
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV

NOTE (1) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

12.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

12.6 OPERATION

12.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .

12.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE ; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY ; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR . WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY .

12.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .

12.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE .
IF ABOVE SEQUENCE IS NOT FOLLOWED , CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM .

12.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!
DO NOT STRESS FPC AND IC ON THE MODULE!

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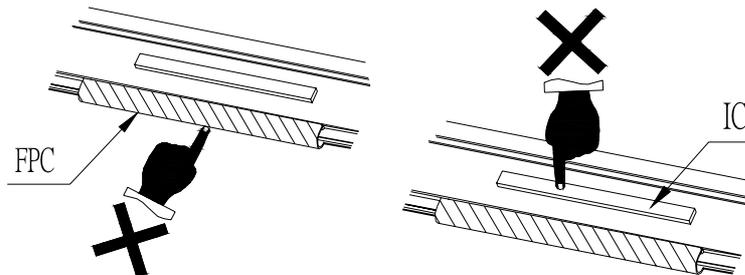
12.7 NOTICE

12.7.1　USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .

12.7.2　DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .

12.7.3　DO NOT CHARGE STATIC ELECTRICITY , AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL .

12.7.4　ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE ; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE .

12.7.5　DON'T GIVE EXTERNAL SHOCK.

12.7.6　DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.

12.7.7　LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.

12.7.8　DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.

12.7.9　STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.

12.7.10　STORE WITHOUT ANY PHYSICAL LOAD.

12.7.11　REWIRING: NO MORE THAN 3 TIMES.